



5340-pixel × 6 line CCD Linear Sensor (Color)

Description

The ILX569K is a reduction type CCD linear sensor developed for color image scanner. This sensor reads A4-size documents at a density of 600 DPI and 1200 DPI.

Sensor Line Features

- Number of effective pixels:
 - 32040 pixels (5340 pixels \times 6)
- Pixel size: $4\mu m \times 4\mu m$ ($4\mu m$ pitch)
- Distance between main line: 48µm (12 lines)
- Distance between main line and sub line: 8µm (2 lines)

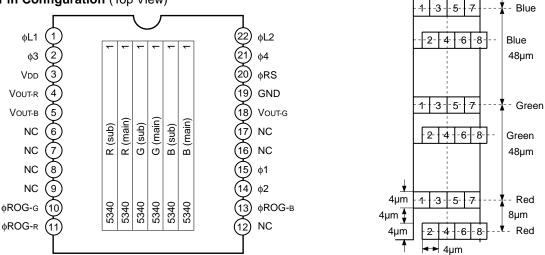
Common Features

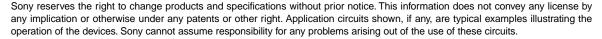
- Single-sided readout
- Ultra low lag
- Single 12V power supply
- Maximum data rate: 8MHz/Color
- Input clock pulse: CMOS 5V drive
- Number of output: 3 (R, G, B)
- Package: 22 pin Plastic-DIP (400mil)

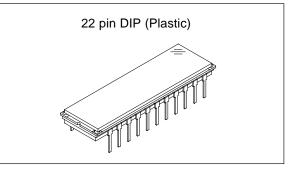
Absolute Maximum Ratings

- Supply voltage VDD 15 V
- Operating temperature -10 to +55 °C

Pin Configuration (Top View)

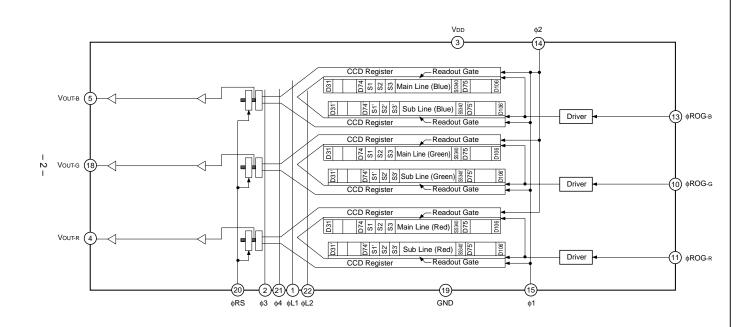






Sensor Configuration

Block Diagram



Pin Description

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	φL1	Clock pulse input	12	NC	NC
2	φ3	Clock pulse input	13	фROG-в	Clock pulse input
3	Vdd	12V power supply	14	φ2	Clock pulse input
4	Vout-r	Signal output (red)	15	φ1	Clock pulse input
5	Vоит-в	Signal output (blue)	16	NC	NC
6	NC	NC	17	NC	NC
7	NC	NC	18	Vout-g	Signal output (green)
8	NC	NC	19	GND	GND
9	NC	NC	20	φRS	Clock pulse input
10	∲ROG-g	Clock pulse input	21	ф 4	Clock pulse input
11	φ ROG -R	Clock pulse input	22	φL2	Clock pulse input

Recommended Supply Voltage

Item	Min.	Тур.	Max.	Unit
Vdd	11.4	12	12.6	V

Clock Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit
Input capacity of \u03c61, \u03c62	Cφ1, Cφ2	—	1500	—	pF
Input capacity of ϕRS	Cørs	_	10	_	pF
Input capacity of ϕ ROG	Cộrog	_	10		pF
Input capacity of \$\$, \$4, \$L1, \$L2	Сфь1, Сфь2, Сф3, Сф4		20		pF

Clock Frequency

Item	Symbol	Min.	Тур.	Max.	Unit
φ1, φ2, φL1, φL2	fφ1, fφ2, fφL1, fφL2	_	0.5	8	MHz
φ3, φ4, φRS	fø3, fø4, førs	_	1	8	MHz

Input Clock Pulse Voltage Condition

ltem	Min.	Тур.	Max.	Unit	
φ1, φ2, φRS, φROG, φL1, φL2, φ3, φ4 pulse voltage	High level	4.75	5.0	5.25	V
	Low level		0	0.1	V

Electrooptical Characteristics (Note 1)

(Ta = 25°C, VDD = 12V, f\u00f3Rs = 1MHz, Input clock = 5Vp-p, Light source = 3200K, IR cut filter CM-500S (t = 1.0mm))

Item		Symbol	Min.	Тур.	Max.	Unit	Remarks
	Red	RR	1.3	1.8	2.3		
Sensitivity	Green	Rg	1.2	1.7	2.2	V/(lx · s)	Note 2
	Blue	Rв	0.8	1.2	1.6		
Sensitivity nonuniformity		PRNU	—	4	20	%	Note 3
Saturation output voltage	Saturation output voltage		1.8	2.0	—	V	Note 4
	Red	SER	—	1	—		
Saturation exposure	Green	SEG	_	1	_	lx⋅s	Note 5
	Blue	SЕв		1.64			
Dark voltage average		Vdrk	—	0.1	1.6	mV	Note 6
Dark signal nonuniformity	Dark signal nonuniformity		—	0.5	3.2	mV	Note o
Image lag		IL	—	0.02	_	%	Note 7
Supply current		Ivdd	—	30	45	mA	Note 8
Total transfer efficiency		TTE	92	98	_	%	
Output impedance		Zo	—	360	_	Ω	
Offset level	Vos	—	5.7		V	Note 9	

Notes:

- 1. In accordance with the given electrooptical characteristics, the black level of 1200 DPI is defined as the average value of D32, D33 to D73.
- 2. For the sensitivity test light is applied with a uniform intensity of illumination.
- PRNU is defined as indicated below. Ray incidence conditions are the same as for Note 2. Vout = 500mV (typ.)

$$\mathsf{PRNU} = \frac{(\mathsf{V}_{\mathsf{MAX}} - \mathsf{V}_{\mathsf{MIN}})/2}{\mathsf{V}_{\mathsf{AVE}}} \times 100 \ [\%]$$

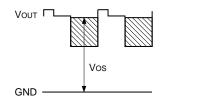
- 4. Use below the minimum value of the saturation output voltage.
- 5. Saturation exposure is defined as follows.

$$\mathsf{SE} = \frac{\mathsf{V}_{\mathsf{SAT}}}{\mathsf{R}}$$

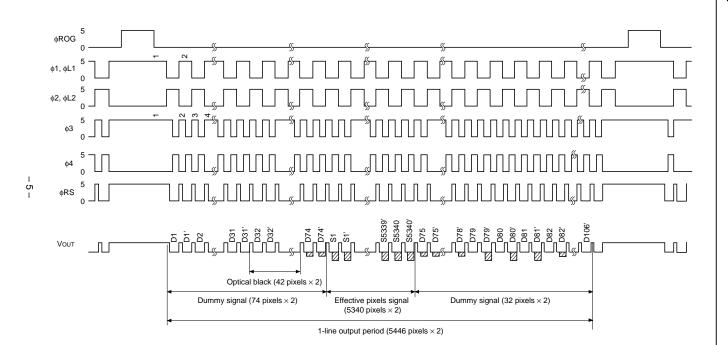
Where R indicates RR, RG, RB and SE indicates SER, SEG, SEB.

- 6. Optical signal accumulated time τ int stands at 4ms.
- 7. $V_{OUT-G} = 500 \text{mV} (\text{typ.})$
- 8. Supply current means the total current of this device.
- 9. Vos is defined as indicated bellow.

Vout indicates Vout-R, Vout-G, and Vout-B.



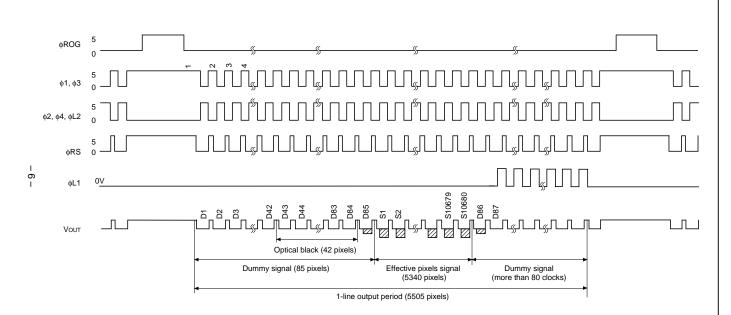




Note) The transfer pulses (ϕ 1, ϕ 2) must have more than 5446 cycles. The transfer pulses (ϕ 3, ϕ 4) must have more than 10892 cycles. Vout indicates Vout-R, Vout-G, Vout-B.

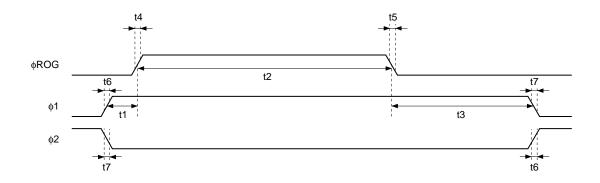
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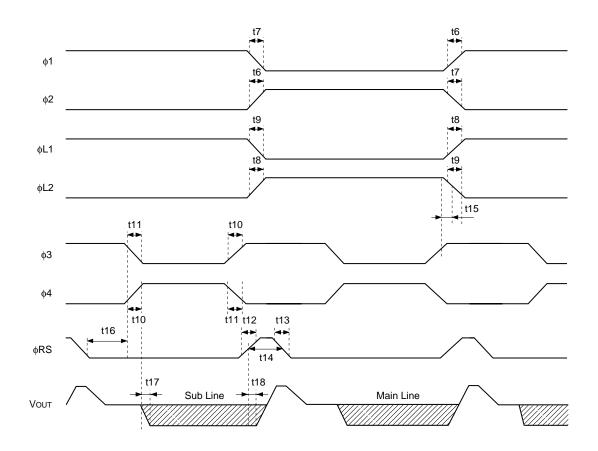


Note) The transfer pulses ($\phi1,\,\phi2)$ must have more than 5505 cycles. Vout indicates Vout-R, Vout-G, Vout-B.

Clock Timing Chart 3



ClockTiming Chart 4

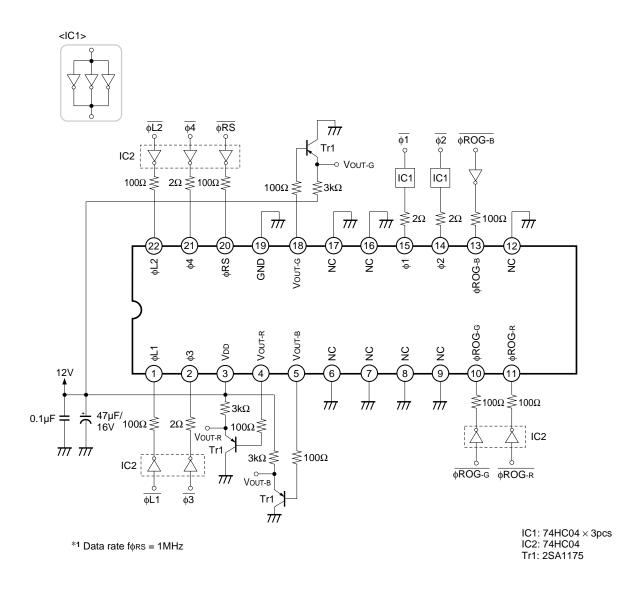


Clock Pulse Recommended Timing

ltem	Symbol	Min.	Тур.	Max.	Unit
φROG, φ1 pulse timing	t1	50	100		ns
	t2	5000	6000		ns
	t3	1200	1500		ns
φROG pulse rise time	t4	0	5	10	ns
♦ROG pulse fall time	t5	0	5	10	ns
φ1 pulse rise time/φ2 pulse fall time	t6	0	50	80	ns
φ1 pulse fall time/φ2 pulse rise time	t7	0	50	80	ns
	t8	0	10	30	ns
	t9	0	10	30	ns
φ3 pulse rise time/φ4 pulse fall time	t10	0	10	30	ns
φ3 pulse fall time/φ4 pulse rise time	t11	0	10	30	ns
φRS pulse rise time	t12	0	10	30	ns
φRS pulse fall time	t13	0	10	30	ns
	t14	60	120*1	—	ns
φL1, φL2 and φ3 pulse timing	t15	0	10	—	ns
φRS, φ3 pulse timing	t16	60	250*1	_	ns
Signal output delay time	t17	—	40	_	ns
Signal output delay time	t18		20		ns

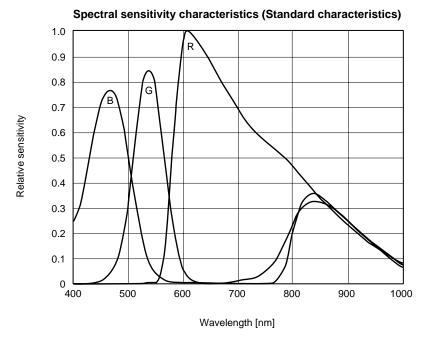
 *1 These timing data is the recommended condition under $f\phi_{\text{RS}}$ = 1MHz.

Application Circuit^{*1}



Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

Example of Representative Characteristics



Notes on Handling

1. Static charge prevention

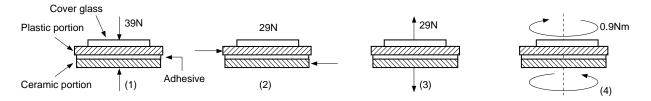
CCD image sensors are easily damaged by static discharge. Before handling be sure to take the following protective measures.

- a) Either handle bare handed or use non-chargeable gloves, clothes or material. Also use conductive shoes.
- b) When handling directly use an earth band.
- c) Install a conductive mat on the floor or working table to prevent the generation of static electricity.
- d) Ionized air is recommended for discharge when handling CCD image sensors.
- e) For the shipment of mounted substrates, use boxes treated for the prevention of static charges.

2. Notes on handling CCD packages

The following points should be observed when handling and installing packages.

- a) Remain within the following limits when applying a static load to the package.
 - (1) Compressive strength: 39N/surface (Do not apply load more than 0.7mm inside the outer perimeter of the glass portion.)
 - (2) Shearing strength: 29N/surface
 - (3) Tensile strength: 29N/surface
 - (4) Torsional strength: 0.9Nm

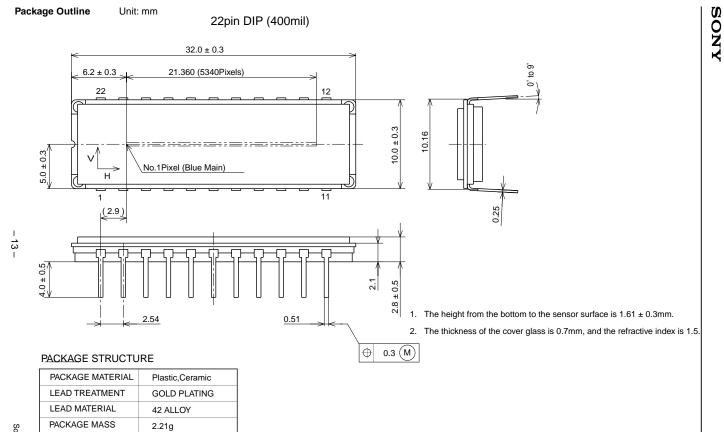


- b) In addition, if a load is applied to the entire surface by a hard component, bending stress may be generated and the package may fracture, etc., depending on the flatness of the ceramic portion. Therefore, for installation, either use an elastic load, such as a spring plate, or an adhesive.
- c) Be aware that any of the following can cause the packege to crack or dust to be generated.
 - (1) Applying repetitive bending stress to the external leads.
 - (2) Applying heat to the external leads for an extended period of time with soldering iron.
 - (3) Rapid cooling or heating.
 - (4) Prying the plastic portion and ceramic portion away at a support point of the adhesive layer.
 - (5) Applying the metal a crash or a rub against the plastic portion.

Note that the preceding notes should also be observed when removing a component from a board after it has already been soldered.

- 3. Soldering
 - a) Make sure the package temperature does not exceed 80°C.
 - b) Solder dipping in a mounting furnance causes damage to the glass and other defects. Use a grounded 30W soldering iron and solder each pin in less than 2 seconds. For repairs and remount, cool sufficiently.
 - c) To dismount an image device, do not use a solder suction equipment. When using an electric desoldering tool, ground the controller. For the control system, use a zero-cross type.

- 4. Dust and dirt protection
 - a) Operate in clean environments.
 - b) Do not either touch glass plates by hand or have any object come in contact with glass surfaces. Should dirt stick to a glass surface, blow it off with an air blower. (For dirt stuck through static electricity ionized air is recommended.)
 - c) Clean with a cotton bud and ethyl alcohol if the glass surface is grease stained. Be careful not to scratch the glass.
 - d) Keep in a case to protect from dust and dirt. To prevent dew condensation, preheat or precool when moving to a room with great temperature differences.
- 5. Exposure to high temperatures or humidity will affect the characteristics. Accordingly avoid storage or usage in such conditions.
- 6. CCD image sensors are precise optical equipment that should not be subject to mechanical shocks.



ILX569K

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DRAWING NUMBER

LS-D18(E)